

PIEZOELECTRIC THIN FILMS (PZT) DEPOSITED WITH PULSED LASER DEPOSITION (PLD) ON 4- TO 8-INCH WAFERS

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In the past years, the industry has realized the potential of piezoelectric MEMS as smart components for a broad range of IoT applications including actuators, sensors, vibration energy harvesters [1],[2] and transducers for RF applications [3].

PZT ($\text{Pb}[\text{Zr}_x\text{Ti}_{1-x}]\text{O}_3$) thin films shows one of the highest piezoelectric coefficients among thin film materials. Their use in MEMS sensors and actuators (called piezo-MEMS) is seeing an increasing number of applications reaching commercial maturity. The industry has a strong request for industry-level deposition processes and Pulsed Laser Deposition (PLD) technique has several advantages over competing ones: high throughput, low materials costs, lower deposition temperature and self-poling options.

Here we present the latest results we achieved depositing PZT thin films on 4- to 8-inch wafers using Solmates B.V. (NL) SMP 800 PLD tool installed at EPFL CMI (Lausanne, Switzerland).

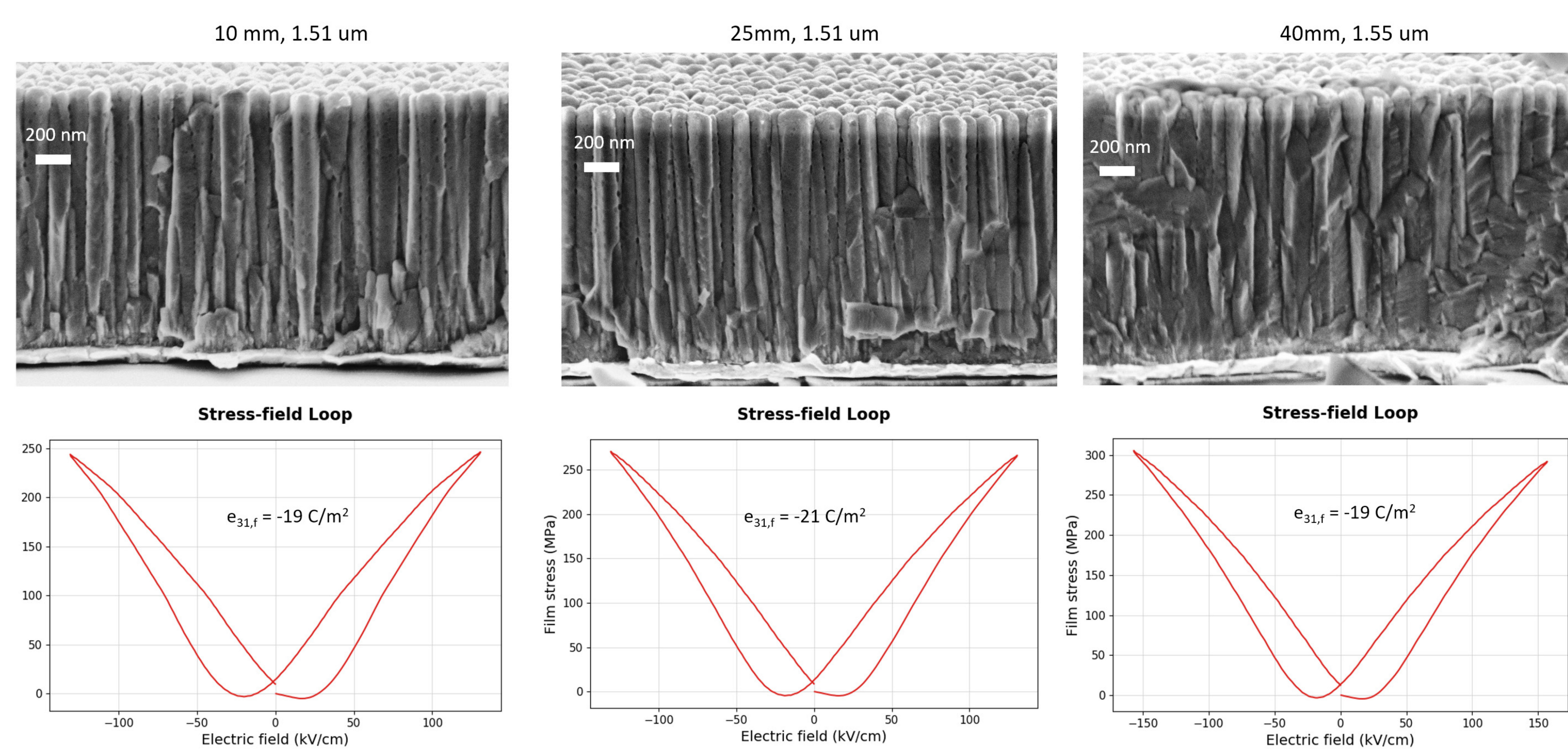


Fig.1: SEM cross section images and effective transverse piezoelectric coefficient of the PZT deposited on 4-inch wafer.

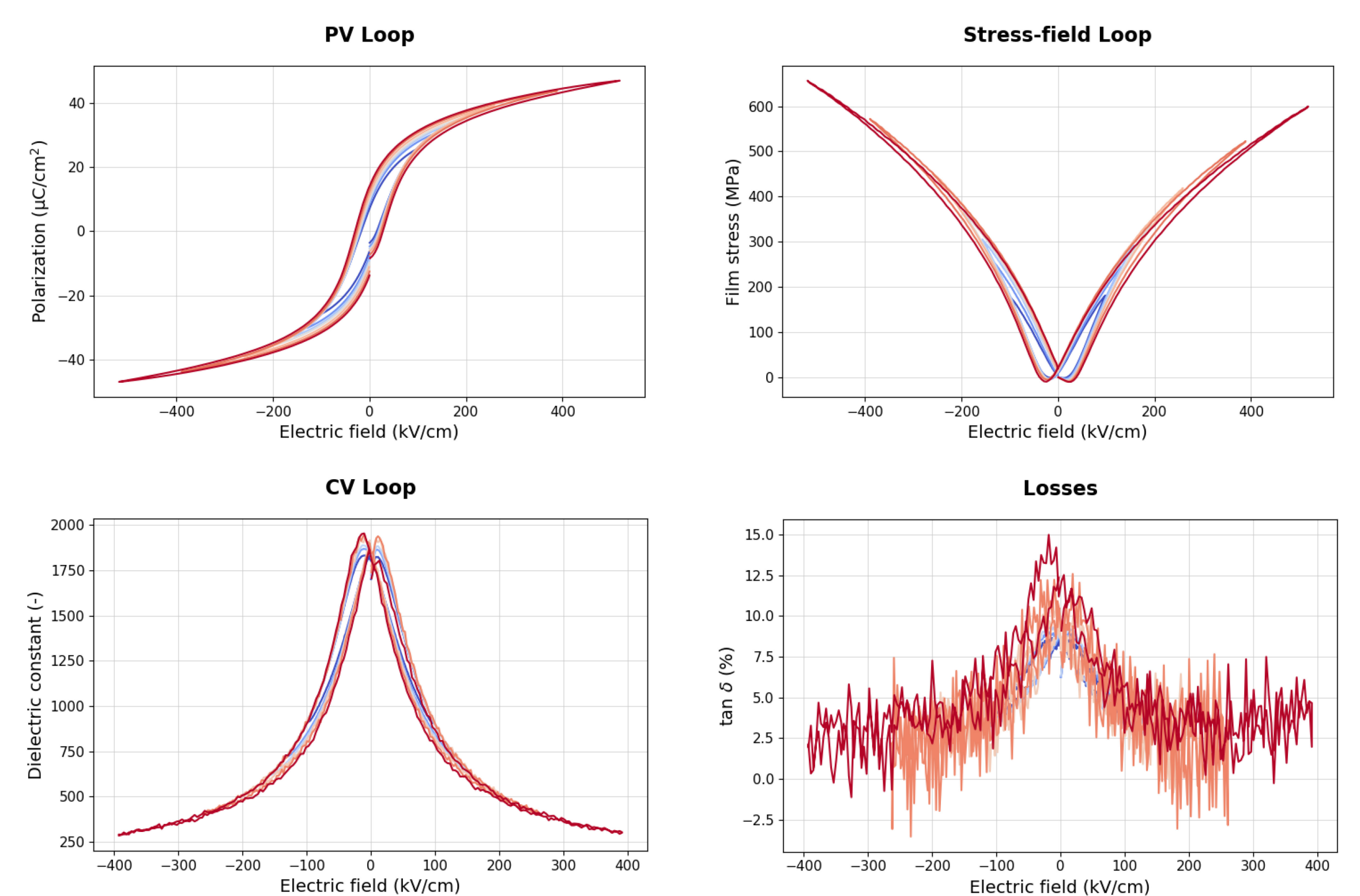


Fig.2: Polarization and stress loops; dielectric permittivity and losses of the PZT deposited on 4-inch wafer.

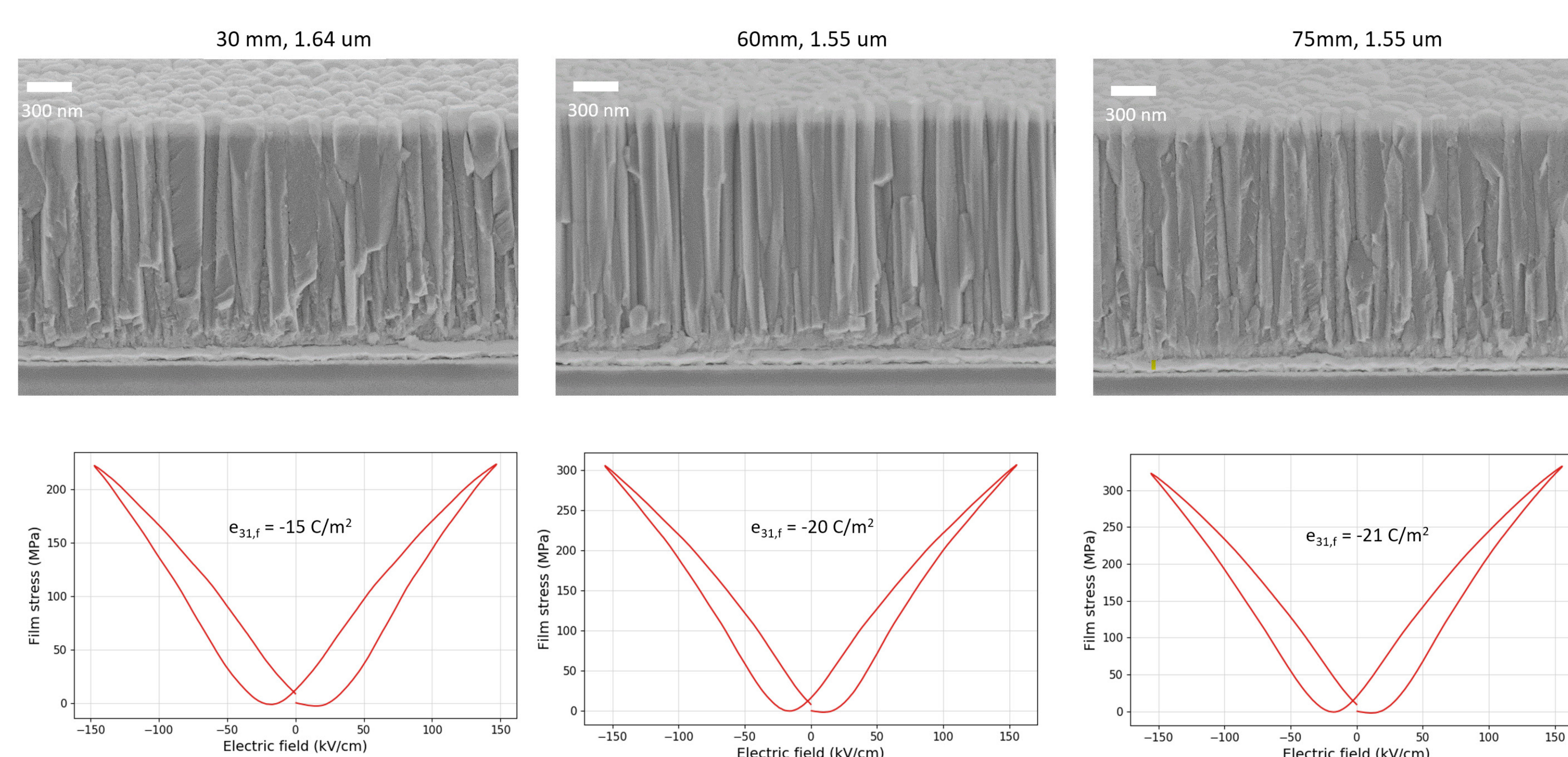


Fig.3: SEM cross section images and effective transverse piezoelectric coefficient of the PZT deposited on 8-inch wafer.

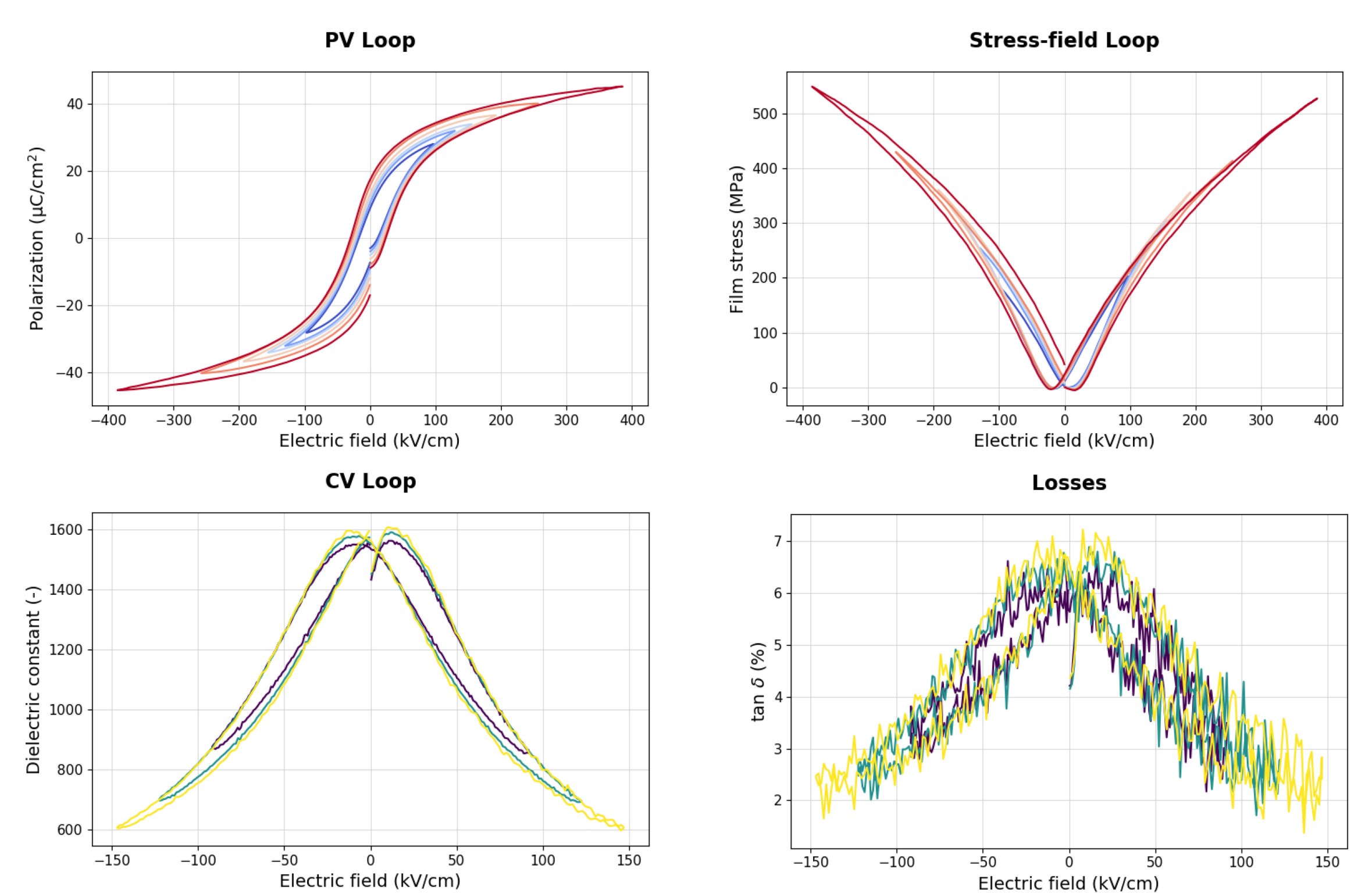


Fig.4: Polarization and stress loops; dielectric permittivity and losses of the PZT deposited on 8-inch wafer.

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“New solutions for fast growing piezoelectric thin film demand for internet of things (IoT)”



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“PZT and Graphene MATerials innovations for advanced opto-Electronic applications in AR and biosensing”



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[1] G. L. Smith et al., “PZT-Based Piezoelectric MEMS Technology,” J AM Ceram Soc, vol. 95, pp. 1777–1792, 2012.

[2] P. Muralt, R. G. Polcawich, and S. Troiler-McKinstry, “Piezoelectric Thin Films for Sensors, Actuators, and Energy Harvesting,” MRS Bull, vol. 34, pp. 658–64, 2009.

[3] R. Ruby, P. Bradley, J. D. Larson, and Y. Oshmyansky, “PCS 1900MHz duplexer using thin film bulk acoustic resonators (FBARs),” Electron. Lett., vol. 35, pp. 794–795, 1999.